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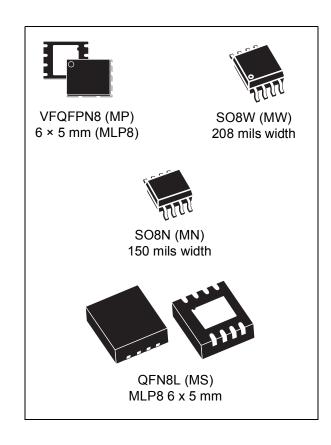


M45PE80

8 Mbit, low voltage, Page-Erasable Serial Flash memory with byte alterability and a 75 MHz SPI bus interface

Features

- SPI bus compatible serial interface
- 75 MHz clock rate (maximum)
- 2.7 V to 3.6 V single supply voltage
- 8 Mbit of Page-Erasable Flash memory
- Page size: 256 bytes:
 - Page Write in 11 ms (typical)
 - Page Program in 0.8 ms (typical)
 - Page Erase in 10 ms (typical)
- Sector Erase (64 Kbytes)
- Hardware Write protection of the bottom sector (64 Kbytes)
- Electronic signature
 - JEDEC standard two-byte signature (4014h)
- Unique ID code (UID) with 16 bytes read only, available upon customer request only on T9HX process technology parts
- Deep Power-down mode 1 µA (typical)
- More than 100 000 Write cycles
- More than 20 years' data retention
- Packages
 - RoHS compliant



Contents M45PE80

Contents

1	Sum	nmary description	6
2	Sign	nal description	8
	2.1	Serial Data Output (Q)	8
	2.2	Serial Data Input (D)	8
	2.3	Serial Clock (C)	8
	2.4	Chip Select (S)	8
	2.5	Reset (Reset)	8
	2.6	Write Protect (W)	8
	2.7	V _{CC} supply voltage	9
	2.8	V _{SS} ground	9
3	SPI	modes	. 10
4	Ope	rating features	. 12
	4.1	Sharing the overhead of modifying data	. 12
	4.2	An easy way to modify data	. 12
	4.3	A fast way to modify data	. 13
	4.4	Polling during a Write, Program or Erase cycle	. 13
	4.5	Reset	. 13
	4.6	Active Power, Stand-by Power and Deep Power-Down modes	. 13
	4.7	Status Register	. 14
	4.8	Protection modes	. 14
5	Mem	nory organization	. 15
6	Instr	ructions	. 17
	6.1	Write Enable (WREN)	. 18
	6.2	Write Disable (WRDI)	. 18
	6.3	Read Identification (RDID)	. 19
	6.4	Read Status Register (RDSR)	. 20
		6.4.1 WIP bit	20

		6.4.2 WEL bit
	6.5	Read Data Bytes (READ)
	6.6	Read Data Bytes at Higher Speed (FAST_READ)
	6.7	Page Write (PW)
	6.8	Page Program (PP)
	6.9	Page Erase (PE)
	6.10	Sector Erase (SE)
	6.11	Deep Power-down (DP)
	6.12	Release from Deep Power-down (RDP)
7	Powe	er-up and Power-down
8	Initial	delivery state
9	Maxir	mum rating
10	DC ar	nd AC parameters
11	Packa	age mechanical41
12	Part r	numbering45
13	Refer	rence
14	Revis	sion history

List of tables M45PE80

List of tables

Table 1.	Signal names	6
Table 2.	Memory organization	. 15
Table 3.	Instruction set	
Table 4.	Read Identification (RDID) data-out sequence	. 19
Table 5.	Status Register Format	. 20
Table 6.	Power-Up timing and VWI threshold	. 32
Table 7.	Absolute maximum ratings	. 33
Table 8.	Operating conditions	. 34
Table 9.	AC measurement conditions	. 34
Table 10.	Capacitance	. 34
Table 11.	DC characteristics	. 35
Table 12.	AC characteristics (33 MHz operation)	. 36
Table 13.	AC characteristics (50 MHz operation)	. 37
Table 14.	AC characteristics (75 MHz operation)	. 38
Table 15.	Reset conditions	. 40
Table 16.	Timings after a Reset Low pulse	. 40
Table 17.	VFQFPN8 (MLP8)8-lead Very thin Fine Pitch Quad Flat Package No lead,	
	6 × 5 mm, package mechanical data	. 41
Table 18.	SO8 wide – 8 lead Plastic Small Outline, 208 mils body width, mechanical data	. 42
Table 19.	SO8N - 8 lead Plastic Small Outline, 150 mils body width, package	
	mechanical data	. 43
Table 20.	QFN8L (MLP8) 8-lead dual flat package no lead, 6 x 5 mm package mechanical data	. 44
Table 21.	Ordering information scheme	. 45
Table 22	Document revision history	46

M45PE80 List of figures

List of figures

Figure 1.	Logic diagram	ხ
Figure 2.	VFQFPN and SO connections	7
Figure 3.	Bus master and memory devices on the SPI bus	10
Figure 4.	SPI modes supported	11
Figure 5.	Block diagram	
Figure 6.	Write Enable (WREN) instruction sequence	18
Figure 7.	Write Disable (WRDI) instruction sequence	
Figure 8.	Read Identification (RDID) instruction sequence and data-out sequence	20
Figure 9.	Read Status Register (RDSR) instruction sequence and data-out sequence	21
Figure 10.	Read Data Bytes (READ) instruction sequence and data-out sequence	22
Figure 11.	Read Data Bytes at Higher Speed (FAST_READ) instruction sequence	
	and data-out sequence	
Figure 12.	Page Write (PW) instruction sequence	
Figure 13.	Page Program (PP) instruction sequence	
Figure 14.	Page Erase (PE) instruction sequence	
Figure 15.	Sector Erase (SE) instruction sequence	
Figure 16.	Deep Power-down (DP) instruction sequence	
Figure 17.	Release from Deep Power-down (RDP) instruction sequence	
Figure 18.	Power-up timing	
Figure 19.	AC measurement I/O waveform	
Figure 20.	Serial input timing	
Figure 21.	Write Protect setup and hold timing	
Figure 22.	Output timing	
Figure 23.	Reset ac waveforms	40
Figure 24.	VFQFPN8 (MLP8) 8-lead Very thin Fine Pitch Quad Flat Package No lead,	
	6 × 5 mm, package outline	
Figure 25.	SO8 wide – 8 lead Plastic Small Outline, 208 mils body width, package outline	
Figure 26.	SO8N - 8 lead Plastic Small Outline, 150 mils body width, package outline	
Figure 27.	QFN8L (MLP8) 8-lead, dual flat package no lead, 6 × 5 mm, package outline	44

№ numonyx 5/48

1 Summary description

The M45PE80 is a 8 Mbit (1 Mbit × 8 bit) Serial Paged Flash Memory accessed by a high speed SPI-compatible bus.

The memory can be written or programmed 1 to 256 bytes at a time, using the Page Write or Page Program instruction. The Page Write instruction consists of an integrated Page Erase cycle followed by a Page Program cycle.

The memory is organized as 16 sectors, each containing 256 pages. Each page is 256 bytes wide. Thus, the whole memory can be viewed as consisting of 4096 pages, or 1 048 576 bytes.

The memory can be erased a page at a time, using the Page Erase instruction, or a sector at a time, using the Sector Erase instruction.

In order to meet environmental requirements, Numonyx offers the M45PE80 in RoHS compliant packages, which are also Lead-free.



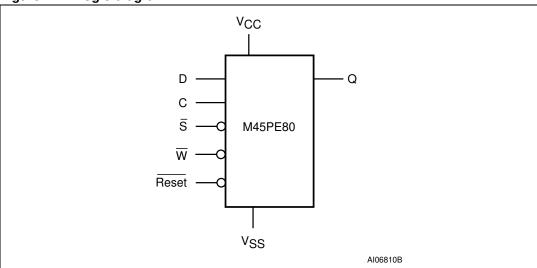
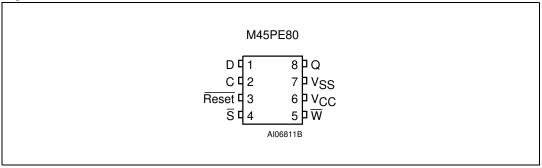


Table 1. Signal names

Signal name	Function	Direction		
С	Serial Clock	Input		
D	Serial Data Input	Input		
Q	Serial Data Output	Output		
S	Chip Select	Input		
\overline{W}	Write Protect	Input		
Reset	Reset	Input		
V _{CC}	Supply Voltage			
V_{SS}	Ground			

Figure 2. VFQFPN and SO connections



- 1. There is an exposed central pad on the underside of the VFQFPN package. This is pulled, internally, to V_{SS} , and must not be allowed to be connected to any other voltage or signal line on the PCB.
- 2. See Section 11: Package mechanical for package dimensions, and how to identify pin-1.

Signal description M45PE80

2 Signal description

2.1 Serial Data Output (Q)

This output signal is used to transfer data serially out of the device. Data is shifted out on the falling edge of Serial Clock (C).

2.2 Serial Data Input (D)

This input signal is used to transfer data serially into the device. It receives instructions, addresses, and the data to be programmed. Values are latched on the rising edge of Serial Clock (C).

2.3 Serial Clock (C)

This input signal provides the timing of the serial interface. Instructions, addresses, or data present at Serial Data Input (D) are latched on the rising edge of Serial Clock (C). Data on Serial Data Output (Q) changes after the falling edge of Serial Clock (C).

2.4 Chip Select (\overline{S})

When this input signal is High, the device is deselected and Serial Data Output (Q) is at high impedance. Unless an internal Read, Program, Erase or Write cycle is in progress, the device will be in the Standby mode (this is not the Deep Power-down mode). Driving Chip Select (\overline{S}) Low enables the device, placing it in the active power mode.

After Power-up, a falling edge on Chip Select (\overline{S}) is required prior to the start of any instruction.

2.5 Reset (Reset)

The Reset (Reset) input provides a hardware reset for the memory.

When Reset (Reset) is driven High, the memory is in the normal operating mode.

When Reset (Reset) is driven Low, the device enters the Reset mode. In this mode, the output Q is high impedance:

If an internal operation (Write, Erase or Program cycle) is in progress when Reset (Reset) is driven Low, the device enters the Reset mode and any on-going Write, Program or Erase cycle is aborted. The addressed data may be lost.

2.6 Write Protect (\overline{W})

This input signal puts the device in the Hardware Protected mode, when Write Protect (\overline{W}) is connected to V_{SS} , causing the first 256 pages of memory to become read-only by protecting them from write, program and erase operations. When Write Protect (\overline{W}) is connected to V_{CC} , the first 256 pages of memory behave like the other pages of memory.

M45PE80 Signal description

2.7 V_{CC} supply voltage

 V_{CC} is the supply voltage.

2.8 V_{SS} ground

 $\rm V_{SS}$ is the reference for the $\rm V_{CC}$ supply voltage.

Numonyx 9/48

SPI modes M45PE80

3 SPI modes

These devices can be driven by a microcontroller with its SPI peripheral running in either of the two following modes:

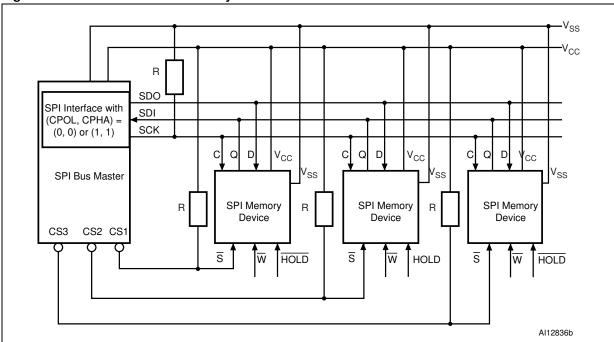
- CPOL=0, CPHA=0
- CPOL=1, CPHA=1

For these two modes, input data is latched in on the rising edge of Serial Clock (C), and output data is available from the falling edge of Serial Clock (C).

The difference between the two modes, as shown in *Figure 4*, is the clock polarity when the bus master is in Stand-by mode and not transferring data:

- C remains at 0 for (CPOL=0, CPHA=0)
- C remains at 1 for (CPOL=1, CPHA=1)

Figure 3. Bus master and memory devices on the SPI bus



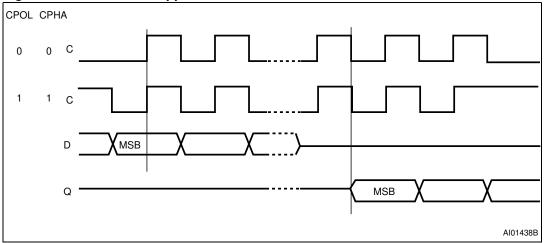
1. The Write Protect (\overline{W}) and Hold (\overline{HOLD}) signals should be driven, High or Low as appropriate.

Figure 3 shows an example of three devices connected to an MCU, on an SPI bus. Only one device is selected at a time, so only one device drives the Serial Data Output (Q) line at a time, the other devices are high impedance. Resistors R (represented in Figure 3) ensure that the M45PE80 is not selected if the Bus Master leaves the \overline{S} line in the high impedance state. As the Bus Master may enter a state where all inputs/outputs are in high impedance at the same time (for example, when the Bus Master is reset), the clock line (C) must be connected to an external pull-down resistor so that, when all inputs/outputs become high impedance, the \overline{S} line is pulled High while the C line is pulled Low (thus ensuring that \overline{S} and C do not become High at the same time, and so, that the t_{SHCH} requirement is met). The typical value of R is 100 kΩ, assuming that the time constant R*C_p (C_p = parasitic capacitance of the bus line) is shorter than the time during which the Bus Master leaves the SPI bus in high impedance.

M45PE80 SPI modes

Example: C_p = 50 pF, that is R*C $_p$ = 5 μs <=> the application must ensure that the Bus Master never leaves the SPI bus in the high impedance state for a time period shorter than 5 μs .

Figure 4. SPI modes supported



Operating features M45PE80

4 Operating features

4.1 Sharing the overhead of modifying data

To write or program one (or more) data bytes, two instructions are required: Write Enable (WREN), which is one byte, and a Page Write (PW) or Page Program (PP) sequence, which consists of four bytes plus data. This is followed by the internal cycle (of duration t_{PW} or t_{PP}).

To share this overhead, the Page Write (PW) or Page Program (PP) instruction allows up to 256 bytes to be programmed (changing bits from 1 to 0) or written (changing bits to 0 or 1) at a time, provided that they lie in consecutive addresses on the same page of memory.

4.2 An easy way to modify data

The Page Write (PW) instruction provides a convenient way of modifying data (up to 256 contiguous bytes at a time), and simply requires the start address, and the new data in the instruction sequence.

The Page Write (PW) instruction is entered by driving Chip Select (S) Low, and then transmitting the instruction byte, three address bytes (A23-A0) and at least one data byte, and then driving Chip Select (S) High. While Chip Select (S) is being held Low, the data bytes are written to the data buffer, starting at the address given in the third address byte (A7-A0). When Chip Select (S) is driven High, the Write cycle starts. The remaining, unchanged, bytes of the data buffer are automatically loaded with the values of the corresponding bytes of the addressed memory page. The addressed memory page then automatically put into an Erase cycle. Finally, the addressed memory page is programmed with the contents of the data buffer.

All of this buffer management is handled internally, and is transparent to the user. The user is given the facility of being able to alter the contents of the memory on a byte-by-byte basis.

For optimized timings, it is recommended to use the Page Write (PW) instruction to write all consecutive targeted bytes in a single sequence versus using several Page Write (PW) sequences with each containing only a few bytes (see *Page Write (PW)*, *Table 13: AC characteristics (50 MHz operation)*, and *Table 14: AC characteristics (75 MHz operation)*).

M45PE80 Operating features

4.3 A fast way to modify data

The Page Program (PP) instruction provides a fast way of modifying data up to 256 contiguous bytes at a time, provided that it involves only resetting bits to 0 that had previously been set to 1. The following are times this use case might occur:

- The designer is programming the device for the first time;
- The designer knows that the page has already been erased by an earlier Page Erase (PE) or Sector Erase (SE) instruction. This is useful, for example, when storing a fast stream of data, having first performed the erase cycle when time was available:
- The designer knows that the change involves only resetting bits to 0 that are still set to 1. When this method is possible, it has the additional advantage of minimizing the number of unnecessary erase operations, and the extra stress incurred by each page.

For optimized timings, it is recommended to use the Page Program (PP) instruction to program all consecutive targeted bytes in a single sequence versus using several Page Program (PP) sequences with each containing only a few bytes (see *Page Program (PP)*, *Table 13: AC characteristics (50 MHz operation)*, and *Table 14.: AC characteristics (75 MHz operation)*).

4.4 Polling during a Write, Program or Erase cycle

A further improvement in the write, program or erase time can be achieved by not waiting for the worst case delay (t_{PW} , t_{PP} , t_{PE} , or t_{SE}). The Write In Progress (WIP) bit is provided in the Status Register so that the application program can monitor its value, polling it to establish when the previous cycle is complete.

4.5 Reset

An internal Power-On Reset circuit helps protect against inadvertent data writes. Addition protection is provided by driving Reset (Reset) Low during the Power-on process, and only driving it High when V_{CC} has reached the correct voltage level, V_{CC} (min).

4.6 Active Power, Stand-by Power and Deep Power-Down modes

When Chip Select (\overline{S}) is Low, the device is enabled, and in the Active Power mode.

When Chip Select (S) is High, the device is disabled, but could remain in the Active Power mode until all internal cycles have completed (Program, Erase, Write). The device then goes in to the Stand-by Power mode. The device consumption drops to I_{CC1} .

The Deep Power-down mode is entered when the specific instruction (the Enter Deep Power-down Mode (DP) instruction) is executed. The device consumption drops further to I_{CC2} . The device remains in this mode until another specific instruction (the Release from Deep Power-down Mode) is executed.

While in the Deep Power-down mode, the device ignores all Write, Program and Erase instructions (see *Deep Power-down (DP)*). This can be used as an extra software protection mechanism, when the device is not in active use, to protect the device from inadvertent Write, Program or Erase instructions.

Operating features M45PE80

4.7 Status Register

The Status Register contains two status bits that can be read by the Read Status Register (RDSR) instruction. See *Section 6.4: Read Status Register (RDSR)* for a detailed description of the Status Register bits.

4.8 Protection modes

The environments where non-volatile memory devices are used can be very noisy. No SPI device can operate correctly in the presence of excessive noise. To help combat this, the M45PE80 boasts the following data protection mechanisms:

- Power-On Reset and an internal timer (t_{PUW}) can provide protection against inadvertent changes while the power supply is outside the operating specification.
- Program, Erase and Write instructions are checked that they consist of a number of clock pulses that is a multiple of eight, before they are accepted for execution.
- All instructions that modify data must be preceded by a Write Enable (WREN) instruction to set the Write Enable Latch (WEL) bit. This bit is returned to its reset state by the following events:
 - Power-up
 - Reset (RESET) driven Low
 - Write Disable (WRDI) instruction completion
 - Page Write (PW) instruction completion
 - Page Program (PP) instruction completion
 - Page Erase (PE) instruction completion
 - Sector Erase (SE) instruction completion
- The Hardware Protected mode is entered when Write Protect (W) is driven Low, causing the first 256 pages of memory to become read-only. When Write Protect (W) is driven High, the first 256 pages of memory behave like the other pages of memory
- The Reset (Reset) signal can be driven Low to protect the contents of the memory during any critical time, not just during Power-up and Power-down.
- In addition to the low power consumption feature, the Deep Power-down mode offers extra software protection from inadvertent Write, Program and Erase instructions while the device is not in active use.

5 Memory organization

The memory is organized as:

- 4096 pages (256 bytes each).
- 1 048 576 bytes (8 bits each)
- 16 sectors (512 Kbits, 65536 bytes each)

Each page can be individually:

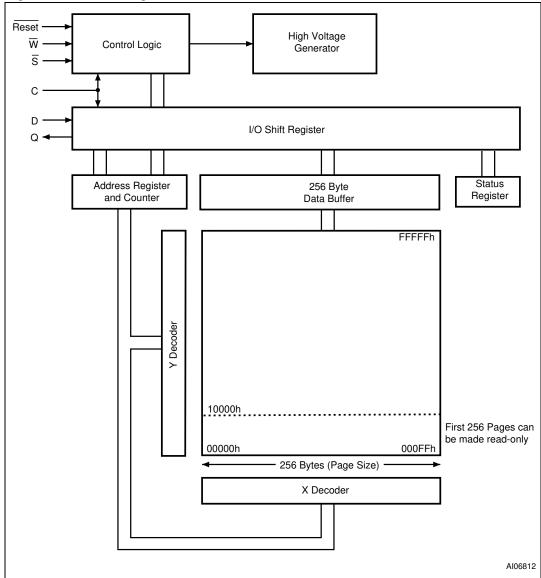
- programmed (bits are programmed from 1 to 0)
- erased (bits are erased from 0 to 1)
- written (bits are changed to either 0 or 1)

The device is Page or Sector Erasable (bits are erased from 0 to 1).

Table 2. Memory organization

Sector	Addres	s range
15	F0000h	FFFFFh
14	E0000h	EFFFFh
13	D0000h	DFFFFh
12	C0000h	CFFFFh
11	B0000h	BFFFFh
10	A0000h	AFFFFh
9	90000h	9FFFFh
8	80000h	8FFFFh
7	70000h	7FFFFh
6	60000h	6FFFFh
5	50000h	5FFFFh
4	40000h	4FFFFh
3	30000h	3FFFFh
2	20000h	2FFFFh
1	10000h	1FFFFh
0	00000h	0FFFFh

Figure 5. Block diagram



6 Instructions

All instructions, addresses, and data are shifted in and out of the device, most significant bit first.

Serial Data Input (D) is sampled on the first rising edge of Serial Clock (C) after Chip Select (S) is driven Low. Then, the one-byte instruction code must be shifted in to the device, most significant bit first, on Serial Data Input (D), each bit being latched on the rising edges of Serial Clock (C). The instruction set is listed in *Table 3*.

Every instruction sequence starts with a one-byte instruction code. Depending on the instruction, this might be followed by address bytes, or by data bytes, or by both or none.

In the case of a Read Data Bytes (READ), Read Data Bytes at Higher Speed (Fast_Read) or Read Status Register (RDSR) instruction, the shifted-in instruction sequence is followed by a data-out sequence. Chip Select (S) can be driven High after any bit of the data-out sequence is being shifted out.

In the case of a Page Write (PW), Page Program (PP), Page Erase (PE), Sector Erase (SE), Write Enable (WREN), Write Disable (WRDI), Deep Power-down (DP) or Release from Deep Power-down (RDP) instruction, Chip Select (S) must be driven High exactly at a byte boundary, otherwise the instruction is rejected, and is not executed. That is, Chip Select (S) must driven High when the number of clock pulses after Chip Select (S) being driven Low is an exact multiple of eight.

All attempts to access the memory array during a Write cycle, Program cycle or Erase cycle are ignored, and the internal Write cycle, Program cycle or Erase cycle continues unaffected.

Table 3. Instruction set

Instruction	Description	One-byte instruction code		Address bytes	Dummy bytes	Data bytes
WREN	Write Enable	0000 0110	06h	0	0	0
WRDI	Write Disable	0000 0100	04h	0	0	0
RDID	Read Identification	1001 1111	9Fh	0	0	1 to 3
RDSR	Read Status Register	0000 0101	05h	0	0	1 to ∞
READ	Read Data Bytes	0000 0011	03h	3	0	1 to ∞
FAST_READ	Read Data Bytes at Higher Speed	0000 1011	0Bh	3	1	1 to ∞
PW	Page Write	0000 1010	0Ah	3	0	1 to 256
PP	Page Program	0000 0010	02h	3	0	1 to 256
PE	PE Page Erase		DBh	3	0	0
SE	SE Sector Erase		D8h	3	0	0
DP	Deep Power-down	1011 1001	B9h	0	0	0
RDP	RDP Release from Deep Power-down		ABh	0	0	0

Instructions M45PE80

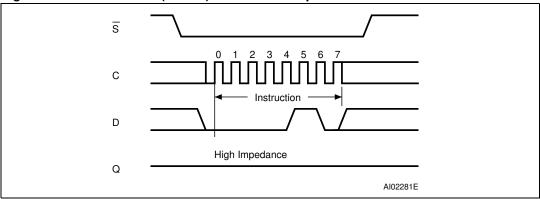
6.1 Write Enable (WREN)

The Write Enable (WREN) instruction (Figure 6) sets the Write Enable Latch (WEL) bit.

The Write Enable Latch (WEL) bit must be set prior to every Page Write (PW), Page Program (PP), Page Erase (PE), and Sector Erase (SE) instruction.

The Write Enable (WREN) instruction is entered by driving Chip Select (\overline{S}) Low, sending the instruction code, and then driving Chip Select (\overline{S}) High.

Figure 6. Write Enable (WREN) instruction sequence



6.2 Write Disable (WRDI)

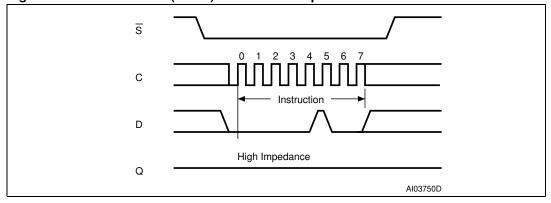
The Write Disable (WRDI) instruction (Figure 7) resets the Write Enable Latch (WEL) bit.

The Write Disable (WRDI) instruction is entered by driving Chip Select (\overline{S}) Low, sending the instruction code, and then driving Chip Select (\overline{S}) High.

The Write Enable Latch (WEL) bit is reset under the following conditions:

- Power-up
- Write Disable (WRDI) instruction completion
- Page Write (PW) instruction completion
- Page Program (PP) instruction completion
- Page Erase (PE) instruction completion
- Sector Erase (SE) instruction completion

Figure 7. Write Disable (WRDI) instruction sequence



6.3 Read Identification (RDID)

The Read Identification (RDID) instruction allows the device identification data to be read as explained here, with the data values shown in *Table 4.: Read Identification (RDID) data-out sequence*.

- Manufacturer identification (1 byte): Numonyx value assigned by JEDEC.
- Device identification (2 bytes): assigned by the device manufacturer.
 - The first byte indicates the memory type.
 - The second byte indicates the memory capacity of the device.
- Unique ID code (UID) (17 bytes): available upon customer request. (1)
 - The first byte contains the length of the data that is contained in the UID.
 - The remaining 16 bytes are available upon customer request and contain the
 optional Customized Factory Data (CFD) content. The CFD bytes are read-only
 and can be programmed with customer data upon customer demand. If a
 customer does not make a request, the device is shipped with all CFD bytes
 programmed to zero (00h).

Any Read Identification (RDID) instruction performed while an Erase or Program cycle is in progress is not decoded, and has no effect on the cycle that is in progress.

The device is first selected by driving Chip Select (S) Low. Then, the 1-byte instruction code for the instruction is shifted in.

After this the 20-bytes stored in memory are shifted out on Serial Data output (Q), including the 3-bytes of manufacturer and device identification information, the 1-byte CFD length, and the 16 bytes of CFD content. Each bit of these 20-bytes is shifted out during the falling edge of Serial Clock (C). The instruction sequence is shown in *Figure 8: Read Identification (RDID) instruction sequence and data-out sequence*.

The Read Identification (RDID) instruction is terminated by driving Chip Select (S) High at any time during data output. When Chip Select (S) is driven High, the device is put in the Stand-by Power mode. Once in the Stand-by Power mode, the device waits to be selected, so that it can receive, decode and execute instructions.

Table 4. Read Identification (RDID) data-out sequence

Manufacturer	Device Ide	Device Identification UID		ID
Identification	Memory Type	Memory Capacity	CFD length	CFD content
20h	40h	14h	10h	16 bytes

19/48

^{1.} UID available on T9HX process technology parts.

Instructions M45PE80

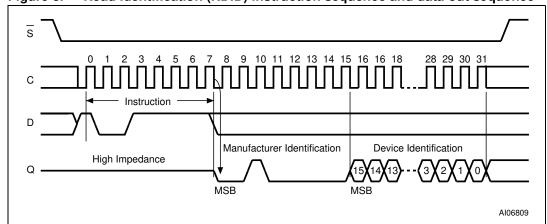


Figure 8. Read Identification (RDID) instruction sequence and data-out sequence

6.4 Read Status Register (RDSR)

The Read Status Register (RDSR) instruction allows the Status Register to be read. The Status Register may be read at any time, even while a Program, Erase or Write cycle is in progress. When one of these cycles is in progress, it is recommended to check the Write In Progress (WIP) bit before sending a new instruction to the device. It is also possible to read the Status Register continuously, as shown in *Figure 9*.

The status bits of the Status Register are as follows:

6.4.1 WIP bit

The Write In Progress (WIP) bit indicates whether the memory is busy with a Write, Program or Erase cycle. When set to 1, such a cycle is in progress, when reset to 0 no such cycle is in progress.

6.4.2 WEL bit

The Write Enable Latch (WEL) bit indicates the status of the internal Write Enable Latch. When set to 1 the internal Write Enable Latch is set, when set to 0 the internal Write Enable Latch is reset and no Write, Program or Erase instruction is accepted.

Table 5. Status Register Format

b7							b0
0	0	0	0	0	0	WEL ⁽¹⁾	WIP ⁽¹⁾

WEL and WIP are volatile read-only bits (WEL is set and reset by specific instructions; WIP is automatically set and reset by the internal logic of the device).

20/48 **№** numonyx

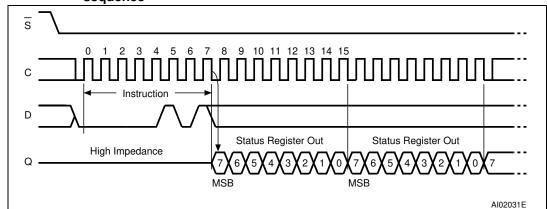


Figure 9. Read Status Register (RDSR) instruction sequence and data-out sequence

6.5 Read Data Bytes (READ)

The device is first selected by driving Chip Select $\overline{(S)}$ Low. The instruction code for the Read Data Bytes (READ) instruction is followed by a 3-byte address (A23-A0), each bit being latched-in during the rising edge of Serial Clock (C). Then the memory contents at that address is shifted out on Serial Data Output (Q), each bit being shifted out at a maximum frequency f_R , during the falling edge of Serial Clock (C). The instruction sequence is shown in *Figure 10*.

The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out. The whole memory can, therefore, be read with a single Read Data Bytes (READ) instruction. When the highest address is reached, the address counter rolls over to 000000h, allowing the read sequence to be continued indefinitely.

The Read Data Bytes (READ) instruction is terminated by driving Chip Select (S) High. Chip Select (S) can be driven High at any time during data output. Any Read Data Bytes (READ) instruction, while an Erase, Program or Write cycle is in progress, is rejected without having any effects on the cycle that is in progress.

Instructions M45PE80

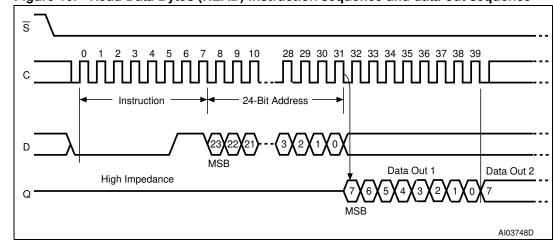


Figure 10. Read Data Bytes (READ) instruction sequence and data-out sequence

1. Address bits A23 to A20 are Don't Care.

6.6 Read Data Bytes at Higher Speed (FAST_READ)

The device is first selected by driving Chip Select $\overline{(S)}$ Low. The instruction code for the Read Data Bytes at Higher Speed (FAST_READ) instruction is followed by a 3-byte address (A23-A0) and a dummy byte, each bit being latched-in during the rising edge of Serial Clock (C). Then the memory contents, at that address, is shifted out on Serial Data Output (Q), each bit being shifted out, at a maximum frequency f_C , during the falling edge of Serial Clock (C).

The instruction sequence is shown in Figure 11.

The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out. The whole memory can, therefore, be read with a single Read Data Bytes at Higher Speed (FAST_READ) instruction. When the highest address is reached, the address counter rolls over to 000000h, allowing the read sequence to be continued indefinitely.

The Read Data Bytes at Higher Speed (FAST_READ) instruction is terminated by driving Chip Select (S) High. Chip Select (S) can be driven High at any time during data output. Any Read Data Bytes at Higher Speed (FAST_READ) instruction, while an Erase, Program or Write cycle is in progress, is rejected without having any effects on the cycle that is in progress.

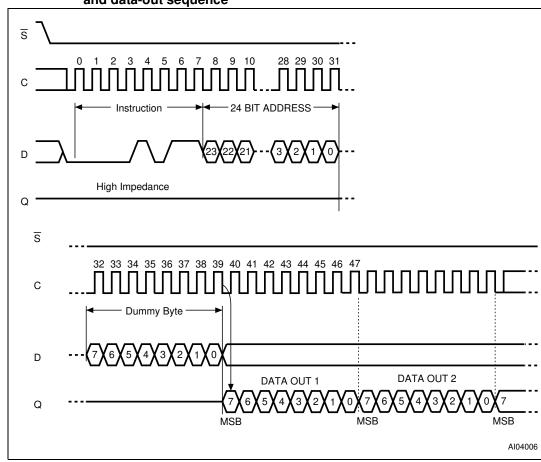


Figure 11. Read Data Bytes at Higher Speed (FAST_READ) instruction sequence and data-out sequence

1. Address bits A23 to A20 are Don't Care.

6.7 Page Write (PW)

The Page Write (PW) instruction allows bytes to be written in the memory. Before it can be accepted, a Write Enable (WREN) instruction must previously have been executed. After the Write Enable (WREN) instruction has been decoded, the device sets the Write Enable Latch (WEL).

The Page Write (PW) instruction is entered by driving Chip Select (S) Low, followed by the instruction code, three address bytes and at least one data byte on Serial Data Input (D). The rest of the page remains unchanged if no power failure occurs and the device is not reset during the write cycle.

The Page Write (PW) instruction performs a page erase cycle even if only one byte is updated.

If the 8 least significant address bits (A7-A0) are not all zero, all transmitted data exceeding the addressed page boundary roll over, and are written from the start address of the same page (the one whose 8 least significant address bits (A7-A0) are all zero). Chip Select (S) must be driven Low for the entire duration of the sequence.

The instruction sequence is shown in Figure 12.

Instructions M45PE80

If more than 256 bytes are sent to the device, previously latched data are discarded and the last 256 data bytes are guaranteed to be written correctly within the same page. If less than 256 Data bytes are sent to device, they are correctly written at the requested addresses without having any effects on the other bytes of the same page.

For optimized timings, it is recommended to use the Page Write (PW) instruction to write all consecutive targeted bytes in a single sequence versus using several Page Write (PW) sequences with each containing only a few bytes (see *Table 13: AC characteristics (50 MHz operation)*) and *Table 14: AC characteristics (75 MHz operation)*).

Chip Select (\overline{S}) must be driven High after the eighth bit of the last data byte has been latched in, otherwise the Page Write (PW) instruction is not executed.

As soon as Chip Select (\overline{S}) is driven High, the self-timed Page Write cycle (whose duration is t_{PW}) is initiated. While the Page Write cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Page Write cycle, and is 0 when it is completed. At some unspecified time before the cycle is complete, the Write Enable Latch (WEL) bit is reset.

A Page Write (PW) instruction applied to a page that is Hardware Protected is not executed.

Any Page Write (PW) instruction, while an Erase, Program or Write cycle is in progress, is rejected without having any effects on the cycle that is in progress.

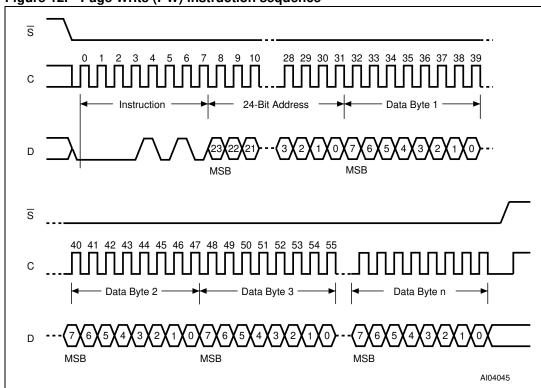


Figure 12. Page Write (PW) instruction sequence

- 1. Address bits A23 to A20 are Don't Care
- 2. $1 \le n \le 256$

6.8 Page Program (PP)

The Page Program (PP) instruction allows bytes to be programmed in the memory (changing bits from 1 to 0, only). Before it can be accepted, a Write Enable (WREN) instruction must previously have been executed. After the Write Enable (WREN) instruction has been decoded, the device sets the Write Enable Latch (WEL).

The Page Program (PP) instruction is entered by driving Chip Select (S) Low, followed by the instruction code, three address bytes and at least one data byte on Serial Data Input (D). If the 8 least significant address bits (A7-A0) are not all zero, all transmitted data exceeding the addressed page boundary roll over, and are programmed from the start address of the same page (the one whose 8 least significant address bits (A7-A0) are all zero). Chip Select (S) must be driven Low for the entire duration of the sequence.

The instruction sequence is shown in *Figure 13*.

If more than 256 bytes are sent to the device, previously latched data are discarded and the last 256 data bytes are guaranteed to be programmed correctly within the same page. If less than 256 Data bytes are sent to device, they are correctly programmed at the requested addresses without having any effects on the other bytes of the same page.

For optimized timings, it is recommended to use the Page Program (PP) instruction to program all consecutive targeted bytes in a single sequence versus using several Page Program (PP) sequences with each containing only a few bytes (see *Table 13: AC characteristics (50 MHz operation)* and *Table 14: AC characteristics (75 MHz operation)*).

Chip Select (\overline{S}) must be driven High after the eighth bit of the last data byte has been latched in, otherwise the Page Program (PP) instruction is not executed.

As soon as Chip Select (S) is driven High, the self-timed Page Program cycle (whose duration is t_{PP}) is initiated. While the Page Program cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Page Program cycle, and is 0 when it is completed. At some unspecified time before the cycle is complete, the Write Enable Latch (WEL) bit is reset.

A Page Program (PP) instruction applied to a page that is Hardware Protected is not executed.

Any Page Program (PP) instruction, while an Erase, Program or Write cycle is in progress, is rejected without having any effects on the cycle that is in progress.